



Welcome to **E-XFL.COM** 

Understanding <u>Embedded - Microcontroller, Microprocessor, FPGA Modules</u>

Embedded - Microcontroller, Microprocessor, and FPGA Modules are fundamental components in modern electronic systems, offering a wide range of functionalities and capabilities. Microcontrollers are compact integrated circuits designed to execute specific control tasks within an embedded system. They typically include a processor, memory, and input/output peripherals on a single chip. Microprocessors, on the other hand, are more powerful processing units used in complex computing tasks, often requiring external memory and peripherals. FPGAs (Field Programmable Gate Arrays) are highly flexible devices that can be configured by the user to perform specific logic functions, making them invaluable in applications requiring customization and adaptability.

#### Applications of **Embedded - Microcontroller**,

Product Status Active  Module/Board Type MPU, FPGA Core  Core Processor ARM® Cortex®-A9, XC7Z020-3  Co-Processor Artix-7  Speed 800MHz  Flash Size 1GB (NAND), 32MB (NOR)  RAM Size 1GB  Connector Type 3 x 140 Pins 0.6mm Pitch  Size / Dimension -  Operating Temperature 0°C ~ 70°C	Details	
Core Processor         ARM® Cortex®-A9, XC7Z020-3           Co-Processor         Artix-7           Speed         800MHz           Flash Size         1GB (NAND), 32MB (NOR)           RAM Size         1GB           Connector Type         3 x 140 Pins 0.6mm Pitch           Size / Dimension         -           Operating Temperature         0°C ~ 70°C	Product Status	Active
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Purchase URL https://www.e-xfl.com/product-detail/dave-embedded-systems/dbrf5110c	Purchase URL	https://www.e-xfl.com/product-detail/dave-embedded-systems/dbrf5110c

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



- Unmatched performance thanks to dual ARM Cortex-A9
   @ 800MHz
- All memories you need: on-board NOR and NAND Flash
- Enabling smarter system thanks to Artix-7 FPGA integrated on chip
- FPGA banks wide range PSU input from 1.2V to 3.3V
- Highest security and reliability: internal voltage monitoring and power good enable
- Reduced carrier complexity: dual CAN, USB, Ethernet GB and native 3.3V I/O
- Easy to fit thanks to its small form factor
- Accurate timing application thanks to on-board 5ppm RTC

BORA is the new top-class Dual Cortex-A9 + FPGA CPU module by DAVE Embedded Systems, based on the recent Xilinx Zynq XC7Z010/XC7Z020 application processor. Thanks to BORA, customers are going to save time and resources by using a compact solution that includes both a CPU and an FPGA, avoiding complexities on the carrier PCB.

The use of this processor enables extensive system-level differentiation of new applications in many industry fields, where high-perfomance and extremely compact form factor (85mm x 50mm) are key factors. Smarter system designs are made possibile, following the trends in functionalities and interfaces of the new, state-of-the-art embedded products.

BORA offers great computational power, thanks to the rich set of peripherals, the Dual Cortex-A9 and the Artix-7 FPGA together with a large set of high-speed I/Os (up to 5GHz).

## **BORA**

# XILINX ZYNQ XC7Z010/XC7Z020 CPU MODULE

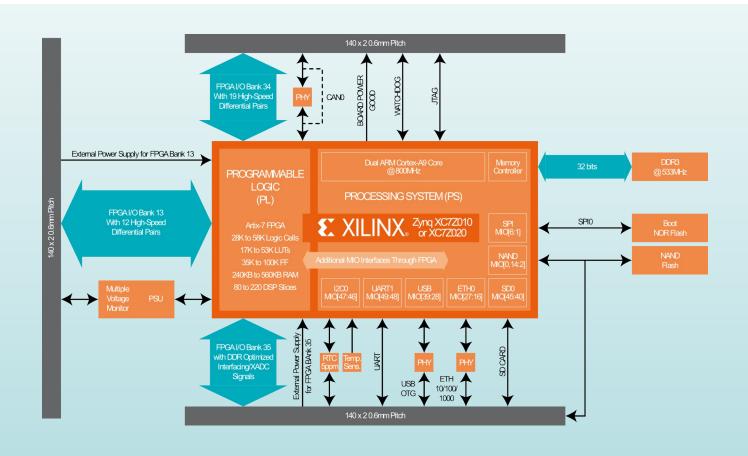


BORA enables designers to create rugged products suitable for harsh mechanical and thermal environments, allowing for the development of the most advanced and robust products.

Thanks to the tight integration between the ARM-based processing system and the on-chip programmable logic, designers are free to add virtually any peripheral or create custom accelerators that extend system performance and better match specific application requirements.

BORA is designed and manufactured according to DAVE Embedded Systems ULTRA Line specifications, in order to guarantee premium quality and technical value for customers who require top performances and flexibility.

BORA is suitable for high-end applications such as medical instrumentation, advanced communication systems, critical real-time operations and safety applications.



CPU	Xilinx Dual ARM Cortex-A9 Zynq XC7Z010/XC7Z020 @ 800MHz				
Supervisor	On-board power supply supervision and power sequencer Watchdog and RTC				
Memory					
Cache	32Kbyte instruction, 32Kbyte data, 512Kbyte L2 for each core				
SDRAM	Up to 1GB DDR3 @ 533MHz				
NOR	Bootable SPI NOR 8, 16, 32 MB				
NAND	All sizes, on request				
SRAM	256 Kbyte				
Interfaces (full-s	spec models) *				
LAN	Ethernet 10/100/1000 Mbps Additional RMII interface				
UART	up to 2x UART ports				
USB	up to 2 x 2.0 OTG ports				
CAN	up to 2 x CAN				

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CAN	up to 2 x CAN			
Debug	JTAG IEEE 1149.1 Test Access Port CoreSight™ and Program Trace Macrocell (PTM)			
Other	PC Card: 2 x SD/SDIO 2.0/MMC 3.31 compliant controllers up to 6 x I <sup>2</sup> C channels up to 6 x SPI channels GPIOs available			
FPGA				
Model	Artix-7			
Logic Cells	28K to 56K			
LUTs	17K to 53K			
Flip Flops 35K to 100K				

DSP Slices	80 to 220
Differential Pairs	up to 34 differential pairs for high freq. interfaces
Mechanical	
Connectors	3 x 140 pin 0.6mm pitch
Size	85mm x 50mm
Temperature	Commercial (0°C / +70°C) Industrial (-40°C / +85°C)
PSII	

240KB to 560KB

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Input	3.3V, on-board voltage regulation		
Software		-	
Bootloader	U-Boot		
Multitasking	Linux 3.x.x		

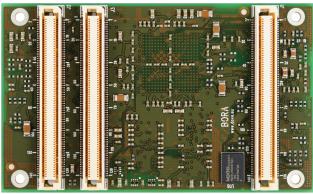
### **Evaluation Kit**

RAM

The BORA evaluation kit is available in a developement kit that includes a SOM, a carrier board and all accessories required for immediate start-up.

\*: interface availability depends on pin multiplexing Please contact your local FAE.





## Product code configurator \*

		, , ,				
Family	Processor	NOR flash	DDR RAM	NAND flash	BOOT	Temp. range
DBR	A: XC7Z010-1 B: XC7Z010-2 C: XC7Z010-3 D: XC7Z020-1 E: XC7Z020-2 F: XC7Z020-3	0= 0MB 3= 8MB 5= 32MB 6= 64MB	1= 1GB 9= 512MB	0= 0MB 1= 1024MB 2= 2048MB 7= 128MB 8= 256MB 9= 512MB	0 = Nor Boot	C: Commercial temp. 0 / +70°C I: Industrial temp. -40 / +85°C





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